General Description

The MAX9480/MAX9481/MAX9482 low-power, low-distortion, class-G, high-current asymmetric digital subscriber line (ADSL) drivers offer Rail-to-Rail[®] output and are ideal for ADSL in central-office applications. Operating from $\pm 5V$ and $\pm 2.5V$ supplies, the drivers incorporate two high-speed current-feedback preamplifiers driving two fixed-gain class-G buffers. The buffers can deliver 20.4dBm average line power with a signal crest factor of 5.3, and are designed to be directly DC or AC bridged across a 1:2.5 transformer.

The MAX9480/MAX9481/MAX9482 employ an active line termination scheme for incoming signals that eliminates the need for back-match resistors, reducing line-card power consumption at full rate to less than half of that required by conventional class-AB line-driver circuits.

The MAX9480 includes a hybrid network and two lownoise, fixed-gain-of-4.6V/V receive amplifiers. The part is designed to recover the receive signal to the same level as that of a conventional line interface circuit that incorporates a 1:2 transformer and standard back-matched hybrid, without degrading signal-to-noise ratio (SNR) or line-impedance sensitivity. The MAX9481 provides only the preamplifiers and buffers without the hybrid or receivers. The MAX9482 provides preamplifiers, buffers, and uncommitted receive amplifiers. All devices have a low-output-impedance shutdown function for saving power when not transmitting.

At full-rate 20.4dBm discrete multitone data transmission (DMT), the total dynamic power dissipation is only 680mW (MAX9480/MAX9482) or 655mW (MAX9481). The MAX9480/MAX9481 are available in a 20-pin TSSOP package and the MAX9482 is available in 28-pin TSSOP and 32-pin QFN packages. All devices operate over the extended -40°C to +85°C temperature range.

Applications

Full-Rate ADSL HDSL Central Office DSLAM

Typical Operating Circuits appear at end of data sheet.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

_Features

 Dissipate Only 655mW While Driving 20.4dBm ADSL Full-Rate DMT-Modulated Signal

- Operate with ±5.0V and ±2.5V Power Supplies
 Complete ADSL Central-Office Line Interface
- Complete ADSL Central-Office Line Interface (MAX9480/MAX9482) Two Preamplifiers plus Class-G Rail-to-Rail Buffers Active Line Termination plus Integrated Hybrid (MAX9480) Low-Noise Uncommitted Receive Amplifiers (MAX9482) Fixed-Gain Receive Amplifiers (MAX9480) Low-Output-Impedance Shutdown Mode
 Preamplifiers, Buffers, and Active Line Termination Functions (MAX9481)
- High-Output-Drive Capability
 15V_{P-P} Differential Output Voltage Swing at
 R_L = 16Ω
 - 500mA Output-Drive
- Low Distortion: -71dBc Highest Harmonic at 1MHz and 14Vp-p
- ♦ High Speed: 250V/µs Slew Rate, 80MHz -3dB Bandwidth (G = -3)
- Thermal Shutdown
- Exposed Pads Improve Thermal Performance

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	PKG CODE
MAX9480EUP	-40°C to +85°C	20 TSSOP-EP**	U20E-4
MAX9481EUP	-40°C to +85°C	20 TSSOP-EP	U20E-4
MAX9482EUI	-40°C to +85°C	28 TSSOP-EP	U28E-4
MAX9482EGJ*	-40°C to +85°C	32 QFN	G3277-2
* Futura product	contact factory fo	r availability	

*Future product—contact factory for availability.

**EP = Exposed pad.



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

BOUT1/BOUT2 Output Short-Circuit Duration to VCC/VEE/VLP/VLMMomentary BOUT1/BOUT2 Output Current20mA OUT1/OUT2 Output Short-Circuit Duration to VCC/VEE/VLP/VLMMomentary OUT1/OUT2 Output Current1A OUT1 to OUT2 Short-Circuit DurationContinuous POUT1/POUT2 Output Short-Circuit Duration to	V _{CC} to V _{EE} +12V V _{LP} to V _{LM} +12V V _{CC} or V _{LP} to DGND -0.3V to +6V V _{CC} to V _{LP} -0.3V to +6V V _{EC} or V _{LM} to DGND -6V to +0.3V V _{EE} or V _{LM} to DGND -6V to +0.3V V _{EE} to V _{LM} -6V to +0.3V V _{EE} to V _{LM} -250mA IN1+, IN1-, IN2+, IN2- (V _{CC} + 0.3V) to (V _{EE} - 0.3V) SHDN (V _{CC} + 0.3V) to (V _{EE} - 0.3V)	/ / / /)
10c	V _{CC} /V _{EF} /V _{LP} /V _{LM} Momentary BOUT1/BOUT2 Output Current	4 / 4 8

POUT1/POUT2 Output Current	100mA
RXP/RXM Output Short-Circuit Duration to VCC/VEE/VLP/VLM	
RXP/RXM Output Current	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
20-Pin TSSOP with Pad Connected to VEE	
(derate 21.7mW/°C above +70°C)	1739mW
20-Pin TSSOP with Floating Pad	
(derate 11.0mW/°C above +70°C)	879mW
28-Pin TSSOP with Pad Connected to V _{EE}	
(derate 23.8mW/°C above +70°C)	1905mW
28-Pin TSSOP with Floating Pad	
(derate 12.8mW/°C above +70°C)	
32-Pin QFN (derate 23.3mW/°C above +70°C).	1860mW*
Operating Temperature Range	
(T _{MIN} , T _{MAX})	
Junction Temperature	
Storage Temperature Range6	
Lead Temperature (soldering, 10s)	+300°C

*Refer to Application Note HFAN-08-1.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +5V, V_{EE} = -5V, V_{LP} = +2.5V, V_{LM} = -2.5V, DGND = 0, R_L = 16\Omega$ is connected from OUT1 to OUT2, SHDN = 0, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values specified at T_A = +25°C. Preamp configured for A_V = +1 with 1k Ω from POUT_ to IN_-.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS	
Dynamic Power Dissipation	PDISS	$V_{OUT(DIFF)} = 1.327V_{RMS},$ crest factor = 5.3	MAX9480/ MAX9482		680		mW	
			MAX9481		655		1	
Dynamic Power Consumption	P _{CONS}	$V_{OUT(DIFF)} = 1.327V_{RMS},$	MAX9480/ MAX9482		790		mW	
		crest factor = 5.3	MAX9481		765			
	Vcc	(Note 2)		4.75	5.00	5.25		
Supply Voltage Range	VEE	(Note 2)		-4.75	-5.00	-5.25	v	
	VLP	(Note 2)		2.25	2.50	2.75		
	VLM	(Note 2)		-2.25	-2.50	-2.75		
Quiescent Supply Current (Including Preamps)		MAX9480, R _L = ∞	V _{CC} , V _{EE}		21.5	35.0	- mA	
			V_{LP}, V_{LM}		22.0	40.0		
	ICC, IEE,	MAX9481, R _L = ∞	V _{CC} , V _{EE}		20.0	34.0		
	I _{LP} , I _{LM}		V _{LP} , V _{LM}		21.0	39.0		
			V _{CC} , V _{EE}		21.5	35.0		
		MAX9482, R _L = ∞	V _{LP} , V _{LM}		22.0	40.0		

MAX9480/MAX9481/MAX9482

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, V_{LP} = +2.5V, V_{LM} = -2.5V, DGND = 0, R_L = 16\Omega$ is connected from OUT1 to OUT2, SHDN = 0, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values specified at T_A = +25°C. Preamp configured for A_V = +1 with 1k Ω from POUT_ to IN_-.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS	
			V _{CC} , V _{EE}		2.1	6.0		
		MAX9480, R _L = ∞	V _{LP} , V _{LM}		1.5	5.0	1	
	L		V _{CC} , V _{EE}		0.6	1.2		
Shutdown Supply Current	I _{SD}	MAX9481, R _L = ∞	V _{LP} , V _{LM}		0.05	0.1	mA	
			V _{CC} , V _{EE}		2.1	6.0	1	
		MAX9482, R _L = ∞	V _{LP} , V _{LM}		1.5	5.0	1	
Transmit Path Power-Supply	PSRR	$V_{CC} - V_{EE} = \pm 4.75 V \text{ to } \pm 5.2$	5V	50	76		-10	
Rejection Ratio (Single Ended)	PSRR	$V_{LP} - V_{LM} = \pm 2.25 V$ to ± 2.7	5V	50	81		dB	
Common-Mode Rejection	CMR	$-200 \text{mV} \le \text{V}_{\text{CM}} \le +200 \text{mV}$			46		dB	
Hybrid Rejection Ratio (MAX9480 Only)	HRR	$V_{OUT(DIFF)} = \pm 1.2V$			35		dB	
Driver-to-Receiver Crosstalk (MAX9482 Only)	Xtalk	f = 100kHz			-69		dB	
SHDN Logic Low	VIL					0.8	V	
SHDN Logic High	VIH			2.0			V	
SHDN Input Current	I _{IH} , I _{IL}	SHDN = 0 or SHDN = V_{CC}				±5.0	μA	
Shutdown Delay Time	t SHDN			4.8		μs		
Shutdown Enable Time	t ENABLE				4		μs	
Intermodulation Distortion	I _{MD}	f1 = 1MHz, f2 = 900kHz, <i>Ty</i> <i>Circuit</i> , V _{OUT(DIFF)} = 2.0V _P -		-66		dB		
DRIVER	•						•	
Maximum RMS Output Power (Typical Operating Circuit)	Роит	DMT modulation (crest factor, Cr = 5.33)		21.4			dBmW	
(Note 3)		CAP modulation (crest factor, $Cr = 4.00$)		24.3			GEIIIV	
Closed-Loop Gain	G	VOUT(DIFF) = 1.2VP-P		-2.7	-3	-3.3	V/V	
Second Harmonic Distortion		$f = 1MHz, V_{OUT(DIFF)} = 14V_{P-P},$ Typical Operating Circuit (Note 4)			-71		dB	
Third Harmonic Distortion		f = 1MHz, V _{OUT(DIFF)} = 14V _{P-P} , <i>Typical</i> <i>Operating Circuit</i> (Note 4)			-74		dB	
Differential Output Voltage Swing	Vout(DIFF)	Typical Operating Circuit (Note 4)			15.0		Vp-p	
OUT_ Voltage Swing (per Amplifier) (Note 4)		D 1000	V _{CC} - V _{OH}		0.5		1	
		B = 1000	IV _{EE} - V _{OL} I		0.5		- V	
	Voh, Vol		VCC - VOH		1.27			
		$R_L = 16\Omega$	IV _{EE} - V _{OL} I		1.21			
BOUT_ Voltage Swing	V _{BOH} ,		V _{CC} - V _{BOH}		0.45			
(per Amplifier) (Note 4)	VBOL	IVEE - VBOLI			0.42		- V	
Peak Output Current	Ιουτ				500		mA	
Differential Output Offset Voltage	VOS(DIFF)	IN1+ = IN2+ = 0			±5		mV	

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, V_{LP} = +2.5V, V_{LM} = -2.5V, DGND = 0, R_L = 16\Omega$ is connected from OUT1 to OUT2, SHDN = 0, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values specified at T_A = +25°C. Preamp configured for A_V = +1 with 1k Ω from POUT_ to IN_-.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Differential Output Offset-Voltage Drift	Vos(drift)			±12		µV/°C	
		$-200 \text{mV} \le \text{V}_{\text{OUT}} \le +200 \text{mV}$		8	10		
Output Resistance (per Amplifier)	Rout	SHDN = V _{CC}		8		Ω	
-3dB Bandwidth	BW			80		MHz	
Slew Rate	SR	V _{OUT} (DIFF) = 14V _{P-P} step		250		V/µs	
Output Noise PSD	PN	f = 100kHz to 1.1MHz, referred to 100Ω line		-127		dBm/Hz	
Capacitive Load Stability		No sustained oscillations		1000		рF	
PREAMPS AND RECEIVERS (No	te 5)						
Open-Loop Transimpedance	ZOL	$-2V \le P_{OUT} \le +2V$		300		kΩ	
		$V_{CC} - V_{EE} = \pm 4.75 V \text{ to } \pm 5.25 V$	50 87				
Power-Supply Rejection Ratio	PSRR	$V_{LP} - V_{LM} = \pm 2.25 V \text{ to } \pm 2.75 V$	50	100		dB	
Input Offset Voltage	VOS			±2	±10	mV	
IN1+, IN2+, RXIN1+, RXIN2+ Bias Current	I _{B+}			±1	±20	μA	
IN1+, IN2+, RXIN1+, RXIN2+ Bias Current Matching	I _{OS+}			±0.7		μΑ	
IN1-, IN2-, RXIN1-, RXIN2- Bias Current	I _{B-}			±2.6	±20	μA	
IN1-, IN2-, RXIN1-, RXIN2- Bias Current Matching	I _{OS-}			±1.2		μA	
	Dui	IN1+, IN2+, RXIN1+, RXIN2+		1.1		MΩ	
Input Resistance	R _{IN}	IN1-, IN2-, RXIN1-, RXIN2-	200		Ω		
Input Capacitance	C _{IN}	IN1+, IN2+, IN1-, IN2-, RXIN1+, RXIN2+, RXIN1-, RXIN2- 2			pF		

Note 1: All devices are 100% production tested at $T_A = +25^{\circ}$ C. Specifications over temperature limits are guaranteed by design. **Note 2:** Guaranteed by the PSRR test.

Note 3: Implied by worst-case output voltage swing (VOUT(DIFF)), crest factor (Cr), and load impedance (RL):

$$P_{\text{DRIVER}} = 10 \log_{10} \left(\frac{250 \times \text{V}^2_{\text{OUT}(\text{DIFF})}}{\text{Cr}^2 \times \text{R}_{\text{L}}} \right) d\text{BmW}$$

Note 4: Device may exceed absolute maximum ratings for power dissipation if unit is subjected to full-scale sinusoids for long periods. See the *Applications Information* section.

Note 5: Receiver specifications guaranteed for MAX9482 only.

Typical Operating Characteristics

 $(V_{CC} = +5V, V_{EE} = -5V, V_{LP} = +2.5V, V_{LM} = -2.5V, DGND = 0, RXIN1+ = RXIN2+ = 0, IN1+ = IN2+ = 0, R_L = 16\Omega$ is connected from OUT1 to OUT2, SHDN = 0, T_A = +25°C, unless otherwise noted. Preamp configured for A_V = +1 with 1k Ω from RXOUT_- to RXIN_-. Receiver configured for A_V = +1 with 1k Ω from POUT_ to IN_-.)



Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, V_{EE} = -5V, V_{LP} = +2.5V, V_{LM} = -2.5V, DGND = 0, RXIN1 + = RXIN2 + = 0, IN1 + = IN2 + = 0, R_L = 16\Omega$ is connected from OUT1 to OUT2, SHDN = 0, T_A = +25°C, unless otherwise noted. Preamp configured for A_V = +1 with 1k Ω from RXOUT_- to RXIN_-. Receiver configured for A_V = +1 with 1k Ω from POUT_ to IN_-.)



RECEIVER AMPLIFIER HARMONIC DISTORTION vs. OUTPUT AMPLITUDE







OUTPUT NOISE vs. FREQUENCY -100 -110 OUTPUT NOISE (dBm/Hz) -120 PREAMP GAIN TT -130 PREAMP GAIN -140 -150 -160 0.0001 0.001 0.01 0.1 1 FREQUENCY (MHz)

POWER DISSIPATION vs. LINE POWER





_Pin Description

PIN							
MAX0400	MAXOAOA	МАХ	(9482	NAME	FUNCTION		
MAX9480	MAX9481	TSSOP	QFN	Ī			
1	2	2	31	POUT1	First Preamp Output		
2	3	3	1	IN1-	First Inverting Input		
3	4	4	2	IN1+	First Noninverting Input		
4	_	11	10	RXP	Positive Receiver Output from Internal Hybrid		
5	5	5	3	DGND	Ground		
6	6	6	4	SHDN	Shutdown Control Pin		
7	—	16	15	RXM	Negative Receiver Output from Internal Hybrid		
8	7	7	5	IN2+	Second Preamp Noninverting Input		
9	8	8	6	IN2-	Second Preamp Inverting Input		
10	9	9	7	POUT2	Second Preamp Output		
11, 20	11, 20	18, 28	17, 28	V_{LM}	-2.5V Negative Power-Supply Voltage		
12, 19	12, 19	19, 27	18, 27	VLP	+2.5V Positive Power-Supply Voltage		
13, 18	13, 18	20, 25	19, 24	V _{CC}	+5V Positive Power-Supply Voltage		
14	14	21	20	OUT2	Second Driver Output		
15, 16	15, 16	22, 23	21, 22	VEE	-5V First Negative Power-Supply Voltage		
17	17	24	23	OUT1	First Driver Output		
_	1	1	30	BOUT1	First Driver Output Sense		
_	10	10	8	BOUT2	Second Driver Output Sense		
_	—	12	11	RXIN1-	First Receiver Inverting Input		
_	_	13	12	RXIN1+	First Receiver Noninverting Input		
_		14	13	RXIN2+	Second Receiver Noninverting Input		
_		15	14	RXIN2-	Second Receiver Inverting Input		
	_	17, 26	9, 16, 25, 26, 29, 32	N.C.	Not Internally Connected		
EP	EP	EP	EP	VEE	Exposed pad internally connected to V _{EE} . See the <i>Applications Information</i> section.		

Detailed Description

The MAX9480/MAX9481/MAX9482 are fully differential line transceivers for ADSL applications. Each transmit path has a high-bandwidth, low-distortion, current-feed-back operational amplifier followed by a fixed-gain class-G output buffer.

The MAX9480/MAX9481/MAX9482 are class-G devices and require two dual power supplies, ±5V and ±2.5V. All preamplifier inputs and outputs are available to allow external gain configuration. The MAX9480 contains an internal hybrid echo cancellation circuit with receiver amplifiers set to a fixed gain of 4.6V/V. The MAX9482 has no internal hybrid, but contains two uncommitted low-noise op amps for coupling to an external hybrid network. The MAX9481 has only the preamp and line-driver circuits.

The two class-G output buffers are internally configured for an inverting gain of three, and employ an active termination scheme that presents an 8 Ω load to incoming signals. The buffers are designed for use with a 1:2.5 line transformer and can deliver 20.4dBm average line power with a signal crest factor of 5.3 into a standard 100 Ω line. The outputs are designed to be directly DC-or AC-bridged across the transformer.

The MAX9480/MAX9481/MAX9482 have a low-output impedance, low-power shutdown mode that is activated by driving SHDN high. Transmit path amplifiers and buffers are disabled while the part is in shutdown, and an 8Ω resistor is coupled directly between OUT_ and the output of a three-state buffer referenced to DGND (0V). The receive amplifiers remain active in shutdown mode.



Figure 1. Current Feedback Amplifier Block Diagram

Applications Information

Theory of Operation

The preamplifiers and receivers are current-feedback amplifiers; thus, their open-loop transfer function is expressed as a transimpedance, $\Delta V_{OUT}/\Delta I_{IN}$, or Z_{OL}. The frequency behavior of their open-loop transimpedance is similar to the open-loop gain of a voltage-feedback amplifier; that is, they have a large DC value that decreases at approximately 6dB per octave. Analyzing the follower with gain, as shown in Figure 1, yields the following transfer function:

$$\frac{V_{OUT}}{V_{IN}} = G \times \frac{Z_{OL(S)}}{Z_{OL(S)} + G \times (R_{IN} + R_F)}$$
 [Equation 1]

where G = A_{VCL} = 1 + (R_F/R_G), and R_{IN} = 1/g_M 200 Ω . At low gains, G x R_{IN} << R_F. Therefore, the closed-loop bandwidth is essentially independent of closed-loop gain. Similarly, Z_{OL} >> R_F at low frequencies, so that:

$$\frac{V_{OUT}}{V_{IN}} = G = 1 + \frac{R_F}{R_G}$$
 [Equation 2]

Shutdown

Forcing SHDN high puts the MAX9480/MAX9481/ MAX9482 into low-power shutdown mode. In shutdown mode, OUT1 and OUT2 are low impedance, and the power-supply currents drop to less than 10% of their normal quiescent operating values. When coming out of shutdown, allow about 1.5µs before commencing operation.

PC Board Layout

Power-Supply Bypassing

The MAX9480/MAX9481/MAX9482 are wide-bandwidth devices and require careful board layout, including the possible use of constant-impedance microstrip or stripline techniques. To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible. With multilayer boards, locate the ground plane on a layer that incorporates no signal or power traces. Observe the following guidelines when designing the board. IC sockets increase parasitic capacitance and inductance, and should not be used. Do not make 90° turns; round all corners. Observe high-frequency bypassing techniques to maintain the amplifier's



accuracy. The bypass capacitors should include a 0.1µF ceramic capacitor between each supply pin and the ground plane, located as close to the package as possible. Additionally, place a 1µF to 10µF ceramic or tantalum capacitor in parallel with each 0.1µF capacitor, and as close to them as possible. Place a 10µF to 15µF low-ESR tantalum capacitor at the V_{CC}, V_{LM}, and V_{LP} power-supply points of entry to the PC board. Place a 100µF to 220µF low-ESR tantalum capacitor at the VEE power-supply point of entry to the PC board. The powersupply traces should lead directly from the board input capacitors to V_{CC} and V_{EE}. To minimize parasitic inductance, keep PC traces short and use surface-mount components. Wire-wrapped boards are much too inductive, and breadboards are much too capacitive; neither should be used. Power-supply sequencing is required; apply ± 5.0 before applying ± 2.5 V.

Exposed-Pad Connection

For optimum electrical performance, the EP of the MAX9480/MAX9481/MAX9482 should be soldered to the PC board and electrically connected to V_{EE} with as wide a trace as possible. If using the EP, the 100µF to 220µF low-ESR tantalum capacitor should be used to decouple the EP to the ground plane of the PC board as close to the EP region as possible. For optimum thermal performance, the EP should be additionally connected to a heat sink, as described in the *Thermal Protection and Power Dissipation* section.

Preamp Output Bypassing

In addition to the above layout considerations, and independent of the gain setting, some high-frequency bypassing of the preamp outputs is necessary to prevent instability arising from the high-frequency input impedance characteristics of the buffers. A 50 Ω resistor in series with a 2200pF ceramic capacitor should be connected between POUT_ and DGND, with a 47pF capacitor connected directly between POUT_ and DGND.

Choosing Feedback and Gain Resistors

The MAX9480/MAX9481/MAX9482 use current-feedback amplifiers. Figure 2 shows the standard inverting and noninverting configurations. Notice that the gain of the noninverting circuit, Figure 2(b), is 1 plus the magnitude of the inverting closed-loop gain. Increasing feedback resistor values decreases peaking. Use the input resistor, R_G , to change the magnitude of the gain. Do not use feedback capacitance.

DC and Noise Errors

There are several error sources to consider when using any operational amplifier, and this applies to the MAX9480/MAX9481/MAX9482 as well. Offset-error terms are given by equations 3 and 4. Voltage and current-noise errors are root-square summed and therefore computed separately. In Figure 3, the total output offset voltage is determined by:

- The input offset voltage, V_{OS}, times the closed-loop gain (1 + (R_F / R_G)).
- The positive input bias current, I_{B+} , times the source resistor, R_S (typically less than 10 Ω), plus the negative input bias current, I_{B-} , times the parallel combination of R_G and R_F . In current-mode feedback amplifiers, the input bias currents may flow into or out of the device. For this reason, there is no benefit to matching the resistance at both inputs, as is common in voltage-feedback amplifiers.



Figure 2. Inverting Gain Configuration and Noninverting Gain Configuration



Figure 3. Input Offset Voltage and Current

The equation for total DC error is:

[Equation 3]

$$V_{OUT} = \left[\left(I_{B+} \right) R_S + \left(I_{B-} \right) \left(R_F \parallel R_G \right) + V_{OS} \right] \left(1 + \frac{R_F}{R_G} \right)$$

The total output-referred noise voltage is:

[Equation 4]

$$e_{n(OUT)} = \left(1 + \frac{R_F}{R_G}\right) \sqrt{\left[(i_{n+})Rs\right]^2 + \left[(i_{n-})R_F ||R_G|^2 + (e_n)^2\right]^2}$$

The MAX9480/MAX9481/MAX9482 have very low noise input voltage (e_n), 3.5nV/ $\sqrt{\text{Hz}}$ (typ). The current noise at the noninverting input (i_{n+}) is 4.0pA/ $\sqrt{\text{Hz}}$ (typ), and the current noise at the inverting input, i_{n-}, is 15pA/ $\sqrt{\text{Hz}}$ (typ).

An example of the DC error calculations, using the MAX9480 data and the *Typical Operating Circuit* where $R_F = R_G = 1k\Omega$ ($R_F \parallel R_G = 500\Omega$) and $R_S = 50\Omega$, gives the following, using equation 3:

$$V_{\text{OUT}} = \begin{bmatrix} (1.0 \times 10^{-6}) 50 + (2.6 \times 10^{-6}) (\frac{1000 \times 1000}{1000 + 1000}) \\ +0.002 \times (1 + \frac{1000}{1000}) \end{bmatrix}$$

where $V_{OUT} = 6.7 \text{mV}$ at the preamp outputs.

Calculating total preamp output noise using equation 4 yields $16.6nV/\sqrt{Hz}$, which then contributes $50nV/\sqrt{Hz}$ at the driver output. The driver noise contributes an additional $35mV/\sqrt{Hz}$, to the overall output noise.



Figure 4. Active Line Termination Scheme, Single Side

Driving Capacitive Loads

The MAX9480/MAX9481/MAX9482 receive amplifiers are optimized for AC performance. They are not designed to drive highly capacitive loads. Reactive loads decrease phase margin and can produce excessive ringing and oscillation.

Output-Impedance Synthesis

To help meet the contradictory requirements of high output power and low-power use, the active termination circuit shown in Figure 5 is used. This circuit is designed to present a line termination of 8Ω . R1 is a physical 1.6Ω resistor voltage feedback from the outboard end of R1 to the noninverting input of the amplifier, introduces positive feedback, which increases the effective output-impedance value from 1.6Ω to 8Ω . Hence, the impedance looking into the port matches the line impedance reflected through the transformer.

Assuming an ideal amplifier, the following equation expresses the output impedance:

$$Z_{OUT} = \frac{R_1}{1 - \left(1 + \frac{R_7}{R_8}\right) \frac{R_{10}}{R_9 + R_{10}}}$$
 [Equation 5]

Substituting the values of the resistors shown in Figure 4 into equation 5, we obtain $Z_{OUT} = 8\Omega$.

The output equivalent circuit for the line driver is shown in Figure 5.





Figure 5. Output Equivalent Circuit

With a 1:2.5 transformer, the two 8Ω impedances realized by the active-feedback network form a perfect line termination. The MAX9480 family's active termination design makes it possible to use a $\pm 5V$ power supply instead of $\pm 12V$ or $\pm 15V$, significantly increasing driver efficiency.

Hybrid Considerations

The MAX9480 includes an internal hybrid coupling circuit to realize the receive function with no external components. The hybrid couples the transmitted signal from the line-driver port (Tx port) to the line port and cancels the echo in the receiving port (Rx port). The hybrid circuit is detailed in Figure 6. If using the MAX9481 or the MAX9482, external circuitry must be added to realize a receive function. The MAX9482 includes two uncommitted op amps for this purpose.

A traditional hybrid network with a 2:1 resistor ratio must be replaced with a 1.2:1 ratio to achieve nominal echo cancellation. Additionally, the use of a synthesized output impedance has the side effect of preventing a "virtual-ground" condition at the driver output (BOUT), as seen by the receive signal. Hence, the resulting hybrid circuit exhibits an increased attenuation of the receive signal with respect to a traditional case with no synthesis. For central-office ADSL applications, the noise specifications allow this trade-off to be made.

Pseudo-Class-G Amplifier

The driver consists of two stages: the current-feedback preamplifier and the voltage-feedback buffer. To save power, the preamplifier uses a power supply of only ± 2.5 V. The output swing of the preamplifier is about 3.0VP-P. The buffer is designed as a pseudo-class-G amplifier with a fixed gain of -3V/V. This buffer stage employs two power supplies: a lower voltage supply, ± 2.5 V, and a higher voltage supply, ± 5 V. In the differential driver, two parallel amplifiers provide the output current to the load, as shown in Figure 7.

In this pseudo-class-G amplifier, there is no abrupt supply switchover between the higher voltage and the lower voltage amplifiers, as in a traditional class G. It is a seamless transition that depends only on the amplitude of the input signal and the gain. The lower voltage amplifier has a high conversion conductance, GA, and the higher voltage amplifier has a low conductance, GB. With a low input voltage, the lower voltage amplifier provides most of the output current to the load. As the voltage of the input signal increases, the lower voltage amplifier starts to saturate and the higher voltage amplifier begins to drive the output.



Figure 6. Hybrid Circuit in the MAX9480



This smooth transition between the lower voltage amplifier and the higher voltage amplifier guarantees no glitch on the output signal, and ensures high linearity for high output power, while at the same time consuming minimum power. The relation between the input voltage and the output current of this pseudo-class-G buffer is illustrated in Figure 8.

Thermal Protection and Power Dissipation The MAX9480/MAX9481/MAX9482 are available in the EP version of the TSSOP. The EP facilitates heat transfer out of the package if the pad is soldered to a heat sink made from an area of circuit board copper. Connect this copper dissipation area to VEE. For a DMT-modulated signal with a crest factor greater than or equal to 5.3, the power dissipation of the MAX9480/MAX9481/MAX9482 should not exceed 700mW; the 20-pin TSSOP-EP package with its EP floating allows 714mW peak power at +85°C. Hence, heat sinking is not essential, but is desirable for attaining optimal electrical performance. Note that the part is capable of 500mA peak output current, which could cause thermal shutdown in applications with elevated ambient temperatures and/or signals with low crest factors. The thermal shutdown feature prevents the die temperature from exceeding +150°C. See Figure 9 for a guide to power derating for each of the packages.

Transformer Selection

Full-rate, central-office ADSL requires the transmission of a +20.4dBm (110mW) DMT signal. The DMT signal has a typical crest factor of 5.3, requiring the line driver to provide peak line power of 35.4dBm (3.4W). The 35.4dBm peak line power translates to a 36V peak-topeak differential voltage on a 100 Ω line. The output swing available from the MAX9480 family of line drivers with a ±5V supply is 15.0VP-P, and hence a step-up transformer with turns ratio of 1:2.5 is needed. In the



Figure 7. Output Stage of Pseudo-Class-G Amplifier

Typical Operating Circuit, the MAX9480 is coupled to the phone line through just such a transformer. The total differential load for the MAX9480 is therefore 16Ω . Active termination is included on all devices in the MAX9480 family (as explained above in the *Output-Impedance Synthesis* section).

Receiver Channel Considerations

A step-up transformer at the output of the differential line driver has a step-down effect on signals received from the line. A voltage attenuation equal to the inverse of the turns ratio is realized in the receive channel. This is an addition to the attenuation due to the hybrid circuitry itself (see the *Hybrid Considerations* section).



Figure 8. Amplifier Output Characteristics



Figure 9. Maximum Power Dissipation vs. Temperature



Typical Operating Circuits





Typical Operating Circuits (continued)



Typical Operating Circuits (continued)



Pin Configurations (continued)

Chip Information

MAX9480 TRANSISTOR COUNT: 2557 MAX9481 TRANSISTOR COUNT: 2557 MAX9482 TRANSISTOR COUNT: 2607 **PROCESS: Bipolar**

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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